

PRODUCT DATASHEET Anna-40-3 series





Ordering number C11712 Description C11712_Anna-40-3-W-XP-G

Family Anna-40-3 Type Lens LED XP-G Color Transparent Diameter 40 mm Heiaht 10.7 mm Style Round **PMMA** Optic Material Holder Material Pin, glue Fastening Status Ready

cd/lm Gerber File Available

degrees

28 degrees

Available

degrees

Available

FWHM

FWHM

cd/lm Gerber File

FWHM

cd/lm

Efficiency

Gerber File

Efficiency

Efficiency



Ordering number C11711 Description C11711_Anna-40-3-M-XP-G

Family Anna-40-3 Type Lens **LED** XP-G Color Transparent Diameter 40 mm Height 10.7 mm Round Style Optic Material **PMMA** Holder Material Glue, pin Fastening Status Ready

C11710 Ordering number

Family

C11710_Anna-40-3-S-XP-G Description Anna-40-3

Type Lens XP-G LED Color Transparent Diameter 40 mm 10.7 mm Height Style Round Optic Material **PMMA** Holder Material Fastening Pin, glue Status Ready

NOTE: The typical divergence will be changed by different color, chip size and chip position tolerance. The typical total divergence is the full angle measured where the luminous intensity is half of the peak value.



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GENERAL INFORMATION

- Product series especially designed & optimized for XP-G series of LEDs.
- Special care taken to make light distribution as uniform as possible.
- Lens material optical grade PMMA with high UV and temperature resistance (105 degrees of Celcius / 220 degrees of Fahrenheit). Allows use of high current and temperature conditions.

Please find more information about used material from below: http://ledil.fi/sites/default/files/Documents/Technical/Material/PMMA%208N%20UL94_Yellow%20Card.pdf http://ledil.fi/sites/default/files/Documents/Technical/Material/PMMA%208N%20PLEXIGLAS-Datasheet.pdf

- Fastening to PCB with appropriate adhesive. By clicking link below you can find Ledil recommended glue options.

http://www.ledil.com/datasheets/DataSheet GLUES.pdf

NOTE 1: We advise customer to ensure the suitability and sufficiency of the bond in the end product. For example, mechanical stress, vibration and holes on the surface of the circuit boar weaken the strength of the glue.

NOTE 2: All surfaces where glue is applied must be clean, dry and free from grease and dirt. If cleaning of PCB surfaces is needed, please follow strictly the cleaning instructions of your LED manufacturer -this is important as cleaning shall under no circumstances damage LEDs or other electronics components on the PCB.

Further note that optical components shall not be cleaned with any chemicals - only micro fiber cloth may be used to remove fingerprints or other traces from handling.

